

Parameter	Symbol	Rating	Units	
Load Voltage	VL	40	V	
Load Current	lL .	2.5	Α	
On-Resistance	Ron	0.06	Ω	
I/O Breakdown Voltage	V/ıo	5000	Vrms	









E534710

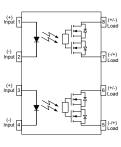
V_L1 (AC,DC)



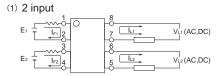
SMD-8

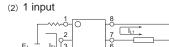


DIP-8



- 1,3. LED Anode
- 2,4. LED Cathode 5,6. Drain (MOS FET)
- 7,8. Drain (MOS FET)





APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

Applications

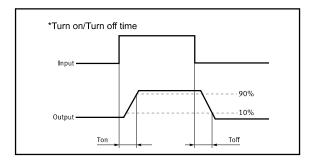
These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Output Rating		Poolsogo	Part No.	Poolsing Quantity		
Category	Load Voltage	Load Current	Package	Fait No.	Packing Quantity	
AC/DC 40V 2000mA	DIP-8	APW211G2E	50pcs /tube			
	2000MA	SMD-8	APW211G2EH	1000pcs /reel		





Absolute Maximum Ratings (Ta = 25°C)

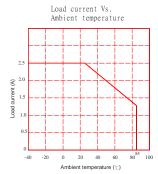
	Item	Symbol	Value	Units	Note
	Continuous LED Current	İF	50	mA	
Input	Peak LED Current	I FP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pin	75	mW	
Output	Load Voltage	V∟	40	V(AC peak or DC)	
	Load Current	l.	2.5	Α	
	Peak Load Current	Peak	4.5	Α	100ms(1 pulse)
	Output Power Dissipation	Pout	1.8	W	
Total Power	Dissipation	Р⊤	2	W	
I/O Breakdov	vn Vo l tage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Te	emperature	Topr	-40 to 85	℃	
Storage Tem	perature	T _{stg}	-40 to 100	℃	
Pin Soldering	g Temperature	T _{sol}	260	℃	10 sec max.

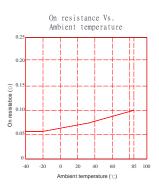
Electrical Characteristics (Ta = 25°C)

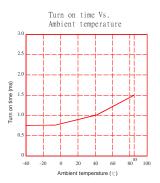
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	VF		1.2	1.4	V	I⊧=10mA
	Operation LED Current	Fon		0.5	3.0	mA	
	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V _{Foff}	0.5			٧	
							I⊧=5mA,I∟=100mA,
Output Off-S	On-Resistance	Ron		0.06	0.1	Ω	Time to flow is within 1 sec.
	Off-State Leakage	Leak	0.01	0.02	0.1	uA	V∟=Rating
	Current	ILEAN	0.01	0.02	0.1	u, t	vi ramg
	Output Capacitance	Cout		190		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.8	1.5	ms	I⊧=5mA, I∟=100mA,
sion	Turn-Off Time	Toff		0.02	0.5	ms	
Counted	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz

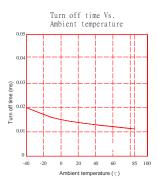
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

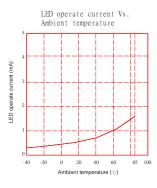
Engineering Data

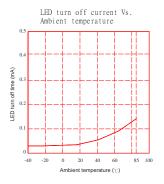


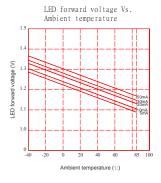


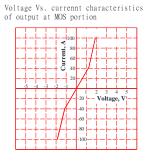


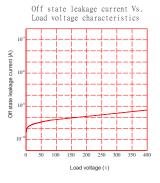


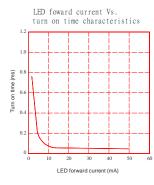


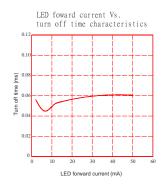


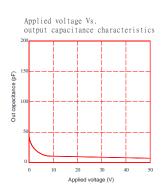








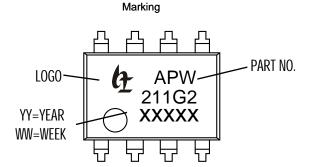






Dimensions and DIP-8 Package

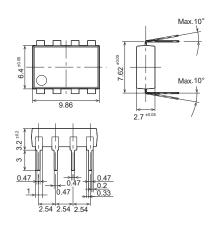
Unit: mm



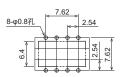
Lable



Through hole terminal type



PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

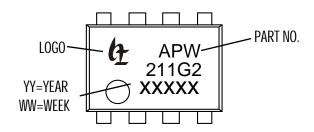
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.





Dimensions and SMD-8 Package Unit: mm

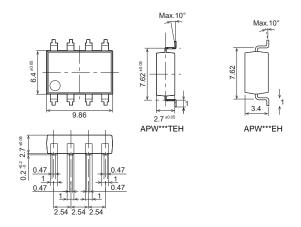
Marking



Lable



Surface mount terminal type



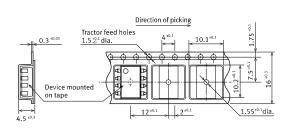
Recommended mounting pad

(Top view)

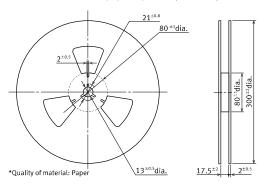


Tape dimensions (tape reel)

Tape dimensions (Unit: mm)



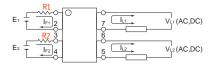
Dimensions of paper tape reel (Unit: mm)





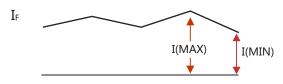
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)			
3.3V	300 Ω			
5.0V	600 Ω			
12V	1.9KΩ			
24V	4.1K Ω			

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



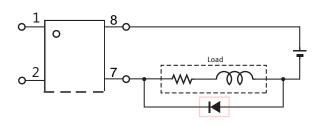
Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

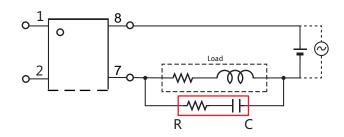
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.



CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



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